

## CPMT Officers

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## Elected Board Members

<b>2011:</b>	Vasudeva Atluri, Koneru Ramakrishna, Patrick Thompson, Paul Wesling, Klaus-Jurgen Wolter, and Kishio Yokouchi
<b>2012:</b>	Chris Bailey, Daniel Donahoe, Paul D. Franzon, S-W (Ricky) Lee, Kwang-Lung Lin, and Leonard W. Schaper
<b>2013:</b>	Debendra Mallik, Toni Mattila, James E. Morris, Eric Perfecto, Dongkai Shangguan, Jean Trehwella

## CPMT Society Newsletter

**Editor-in-Chief:** Kitty Pearsall [kittyp@us.ibm.com](mailto:kittyp@us.ibm.com)

## CPMT Archival Publications

**Transactions on Components, Packaging and Manufacturing Technology**

**Managing Editor:**

R. Wayne Johnson

**Co-Editor, Advanced Packaging:**

Ravi Mahajan

**Co-Editor, Electrical Performance:**

José E. Schutt-Ainé

**Co-Editor, Components: Characterization and Modeling:**

Koneru Ramakrishna

**Co-Editor, Packaging Technologies:**

Kuo-Ning Chiang

**Co-Editor, Electronics Manufacturing:**

R. Wayne Johnson

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**TC-ASTR - Environmental Stress & Reliability Test:**

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**TC-ECCC - Electrical Contacts, Connectors and Cables:**

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**TC-Ed - Education:**

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**TC-EDMS - Electrical Design, Modeling and Simulation:**

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**TC-EM - Manufacturing - Design & Process:**

Vacant

**TC-GEMP - Green Electronics Manufacturing and Packaging:**

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**TC-HDSB - High Density PWB Packaging:**

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Rajen Chanchani

**TC-MEMS - MEMS and Sensor Packaging:**

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**TC-NANO - Nano Packaging:**

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**TC-OPTO - Fiber Optics & Photonics:**

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Douglas Hopkins

**TC-RF+W - RF and Wireless:**

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**TC-SP - Systems Packaging:**

Cian O Mathuna

**TC-Test - Electrical Test:**

Bruce Kim

**TC-Therm - Thermal Management & Thermomech. Design:**

Tony Mak

**TC-WLP - Wafer Level Packaging:**

Michael Toepper

## Strategic Program Directors

**Awards and Recognition:** Patrick Thompson, [patrick.thompson@ti.com](mailto:patrick.thompson@ti.com)

**Conferences:** Jie Xue, [jixue@cisco.com](mailto:jixue@cisco.com)

**Educational Programs:** Kitty Pearsall, [kittyp@us.ibm.com](mailto:kittyp@us.ibm.com)

**Global Chapters and Membership:** Eric Perfecto, [perfecto@us.ibm.com](mailto:perfecto@us.ibm.com)

**Publications:** R. Wayne Johnson, [johnsr7@auburn.edu](mailto:johnsr7@auburn.edu)

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**Constitution and Bylaws:** Tony Mak, [t.mak@ieee.org](mailto:t.mak@ieee.org)

**Distinguished Lecturers:** Kitty Pearsall, [kittyp@us.ibm.com](mailto:kittyp@us.ibm.com)

**Educational Activities:** Vacant

**Fellows Evaluation:** CP Wong, [cp.wong@ieee.org](mailto:cp.wong@ieee.org)

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**Long Range / Strategic Planning:** Philip E. Garrou, [pgarrou/Contractor@rti.org](mailto:pgarrou/Contractor@rti.org)

**Membership:** Eric Perfecto, [perfecto@us.ibm.com](mailto:perfecto@us.ibm.com)

**Nominations:** William Chen, [william.chen@aseus.com](mailto:william.chen@aseus.com)

## Distinguished Lecturers

**Program Director:** Kitty Pearsall, [kittyp@us.ibm.com](mailto:kittyp@us.ibm.com)

**Lecturers:** Albert F. Puttlitz, Ph.D., Avram Bar-Cohen, Ph.D., H. Anthony Chan, Ph.D., Rajen Chanchani, Ph.D., William T. Chen, Ph.D., Badih El-Kareh, Ph.D., Xuejun Fan, Ph.D., Paul D. Franzon, Ph.D., Philip Garrou, Ph.D., George G. Harman, Ph.D., R. Wayne Johnson, Ph.D., George A. Katopis, Ph.D., Jorma Kalvi Kivilahti, D.Sc., John H. Lau, Ph.D., Michael Leppy, Ph.D., Ning-Cheng Lee, Ph.D., S. W. Ricky Lee, Ph.D., Johan Liu, Ph.D., James E. Morris, Ph.D., Kyung W. Paik, Ph.D., T. Paul Parker, Michael Pecht, Ph.D., Karl J. Puttlitz, Ph.D., Bahgat Sammakia, Ph.D., Dongkai Shangguan, Ph.D., Nihal Sinnadurai, Ph.D., Ephraim Suhir, Ph.D., Yong-Khim Swee, Yutaka Tsukada, Ph.D., Rao Tummala, Ph.D., Walter Trybula, Ph.D., E. Jan Vardaman, Paul Wesling, CP Wong, Ph.D., Ralph W. Wyndrum Jr., Ph.D., Kishio Yokouchi, Ph.D.

## Chapters and Student Branches

Refer to [www.cpmc.org](http://www.cpmc.org) for CPMT Society Chapters and Student Branches list

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